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> > Supplementary Information

Solution-processed SiO₂ gate insulator formed at low temperature for zinc oxide thin-film transistors

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Fig. S1. AFM topography images of (a) evaporated Al (b) PHPS spin-coated onto Al and (c) preannealed PHPS film following spin-coating on Al.



Fig. S2. FTIR spectra of spin coated PHPS before and after pre-annealing. These spectra were recorded using a Nicolet Nexus spectrometer with a liquid nitrogen cooled HgCdTe crystal detector. The background spectrum was measured by collecting 128 scans between 400 cm⁻¹ and 4000cm⁻¹ using an Al coated glass slide.

Group vibration	Wavenumber (cm ⁻¹)
Si-O rock	460
Si-N stretch in Si-N-Si	920,840
Si-O stretch	1060
Si-O-Si stretch	1163
N-H bend	1180
Si-H stretch	2160
N-H stretch	3360

Table. S1. IR peak assignments.¹⁻⁵

- 1. H. Matsuo and K. Yamada, Convertech, 1995, 23, 25.
- 2. K. -S. Park, P. -S. Ko and S. -D. Kim, Thin Solid Films, 2014, 551, 57.
- 3. S. -D. Kim, P. -S. Ko and K. -S. Park, Semicond. Sci. Tech., 2013, 28, 035008.
- 4. R. M. Almeida and C. G. Pantano, J. Appl. Phys., 1990, 68, 4225.
- B. C. Trasferetti, R. V. Gelamo, F. P. Rouxinol, M. A. Bica de Moraes and C. U. Davanzo, *Chem. Mater.*, 2005, 17, 4685.